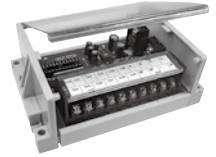


Voice Phone

KSV Series



Part Number Description

KSV - IC **1** (without Speaker)

1 Voice Type 04 : 4 Channel Voice 08 : 8 Channel Voice

KSV - **1** **2** **3**

1 Size S : □ 48mm L : □ 72mm

2 Color S : Silver K : Black

3 Voice Type 04 : 4 Channel Voice 08 : 8 Channel Voice




General Specification

Model	KSV-IC04/08	KSV-L	KSV-S
Power Consumption	Max. Approx. 15W	5W	5W
Maximum Rated Output	Approx. 10W, 90dB/1m	2W 80 ~ 90dB(Phon) / 1m	2W 80 ~ 85dB(Phon) / 1m
Supply Voltage	12/24VDC		
Recordable Memory	64sec (16MHz) / 128sec (8MHz)		
Ambient Temperature	-20 ~ 55 °C (with no icing)		
Insulation Resistance	100MΩ 500VDC		
Dielectric Strength	1,000VAC 1 Minute		
Vibration Resistance	10 ~ 50Hz wavelength 1.5mm		
Tightening Torque	0.5N·m (5.10kgf·cm)		

Note) In case of S Type speaker, life may be shortened when energized continuously for a long time.

• The specification and material of the product can be changed without notice for better quality.
Speaker (IC04/08) : 8 ohm lower than 10W

Product Selection

	Description	Front Part (Speaker) Size	Part Number	
			Silver	Black
	Digital Signal Voice Phone	Large	KSV-LS	KSV-LK
	Digital Signal Voice Phone	Small	KSV-SS	KSV-SK
	4-Channel Voice Phone Chip	-	-	KSV-IC04
	8-Channel Voice Phone Chip	-	-	KSV-IC08

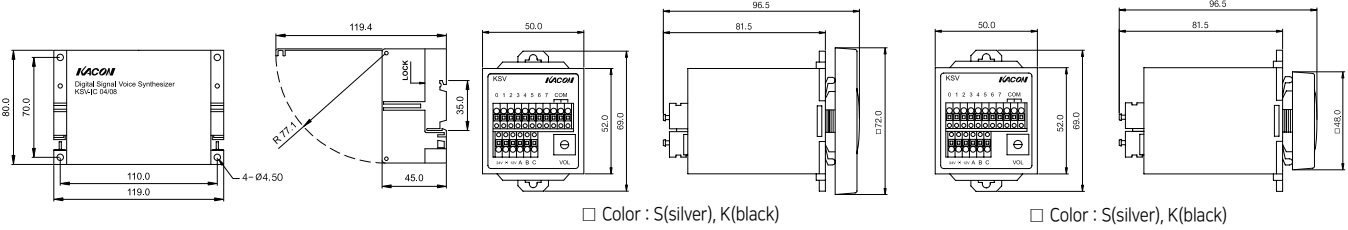
Dimension & Diagram

Unit : mm

KSV-IC04/08

KSV-L □

KSV-S □

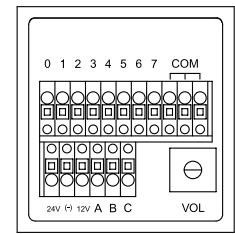
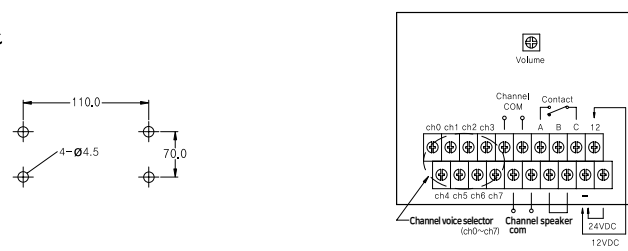
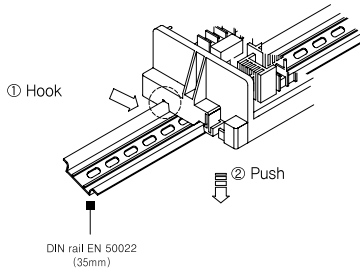


Mounting guide & circuit diagram

KSV-IC04/08

KSV-IC04/08

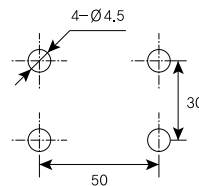
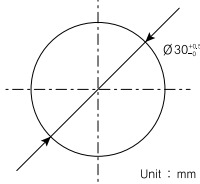
KSV-L KSV-S



KSV-L KSV-S

Attachment hole processing diagram when using a bracket

Panel processing diagram

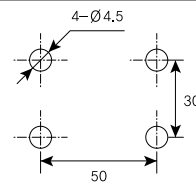


Accessory (KSP-Bracket)



1

Bracket
(for mounting on the exposed surface)



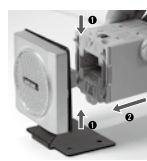
2

3

Volume control



Insert the front part (speaker) in the panel or bracket



Push the device body in the horizontal arrow direction to attach it to the front part. Push the yellow stopper in the up and down arrow directions to maintain the locking state.



Fully mounted state.
[Note] Do not apply excessive force for mounting the device in process 2. The device may be broken.



The volume can be easily controlled using a small driver.
Left direction: volume down
Right direction: volume up